

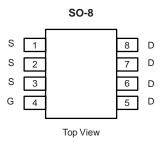
SI9407BDY-T1-GE3-VB Datasheet P-Channel 60 V (D-S) MOSFET

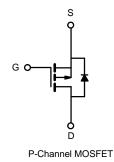
PRODUCT SUMMARY				
V _{DS} (V)	-60			
$R_{DS(on)}(\Omega)$ at V_{GS} = -10 V	0.060			
$R_{DS(on)}\left(\Omega\right)$ at V_{GS} = -4.5 V	0.063			
I _D (A) per leg	-8			

FEATURES

- TrenchFET[®] power MOSFET
- 100 % R_q and UIS tested







ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted) PARAMETER SYMBOL LIMIT UNIT **Drain-Source Voltage** V_{DS} -60 V Gate-Source Voltage V_{GS} ± 20 T_C = 25 °C -8 Continuous Drain Current I_{D} T_C = 125 °C -4.75 Continuous Source Current (Diode Conduction) $I_{\rm S}$ -4.5 A I_{DM} Pulsed Drain Current^a -32 Single Pulse Avalanche Current I_{AS} -22.4 L = 0.1 mH Single Pulse Avalanche Energy E_{AS} 25 mJ $T_C = 25 \degree C$ 5 Maximum Power Dissipation ^a P_D W $T_C = 125 \ ^\circ C$ 1.67 Operating Junction and Storage Temperature Range -55 to +175 °C T_J, T_{stg}

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^b	R _{thJA}	110	°C/W
Junction-to-Foot (Drain)		R _{thJF}	30	0/11

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. When mounted on 1" square PCB (FR-4 material).

c. Parametric verification ongoing.

SPECIFICATIONS ($T_C = 25 \ ^{\circ}C$,	unless otherw	vise noted)					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	·				-		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$		-60	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$			-2.5	
Gate-Source Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V		-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V _{DS} = -60 V	-	-	-1	μΑ
	I _{DSS}	$V_{GS} = 0 V$	V_{DS} = -60 V, T _J = 125 °C	-	-	-50	
		$V_{GS} = 0 V$	V _{DS} = -60 V, T _J = 175 °C	-	-	-150	
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = -10 V$	$V_{DS} \le -5 V$	-30	-	-	А
		$V_{GS} = -10 V$	I _D = -4.3 A	-	0.060	-	Ω
Drain-Source On-State Resistance ^a	В	V _{GS} = -10 V	I _D = -4.3 A, T _J = 125 °C	-	0.070	-	
	R _{DS(on)}	V _{GS} = -10 V	I _D = -4.3 A, T _J = 175 °C	-	0.080	-	
		$V_{GS} = -4.5 V$	I _D = -3.8 A	-	0.063	-	
Forward Transconductance b	9 _{fs}	V _{DS} = -15 V, I _D = -4.3 A		-	13	-	S
Dynamic ^b	·	<u>.</u>					
Input Capacitance	C _{iss}		V _{DS} = -30 V, f = 1 MHz	-	1500	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	334	417	
Reverse Transfer Capacitance	C _{rss}			-	114	142	
Total Gate Charge ^c	Qg			-	43.4	65	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -30 \text{ V}, \text{ I}_{D} = -5 \text{ A}$	-	4.7	-	nC
Gate-Drain Charge ^c	Q _{gd}			-	9	-	
Gate Resistance	Rg		f = 1 MHz		2.5	4	Ω
Turn-On Delay Time ^c	t _{d(on)}				11	17	ns
Rise Time ^c	t _r	V_{DD} = -30 V, R _L = 8.8 Ω I _D \cong -5 A, V _{GEN} = -10 V, R _g = 1 Ω		-	11	17	
Turn-Off Delay Time ^c	t _{d(off)}			-	35	52	
Fall Time ^c	t _f			-	6	9	
Source-Drain Diode Ratings and Char	acteristics ^b	•					
Pulsed Current ^a	I _{SM}			-	-	-32	А
Forward Voltage	V _{SD}	$I_{\rm F} = -2.8 \text{ A}, V_{\rm GS} = 0 \text{ V}$		-	-0.8	-1.2	V
-	1	1			I	l	1

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

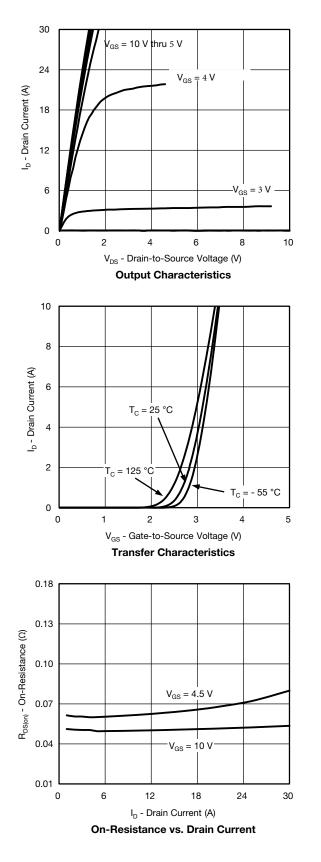
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

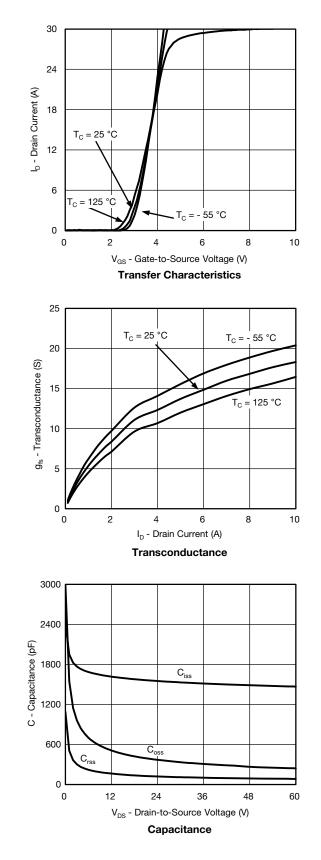
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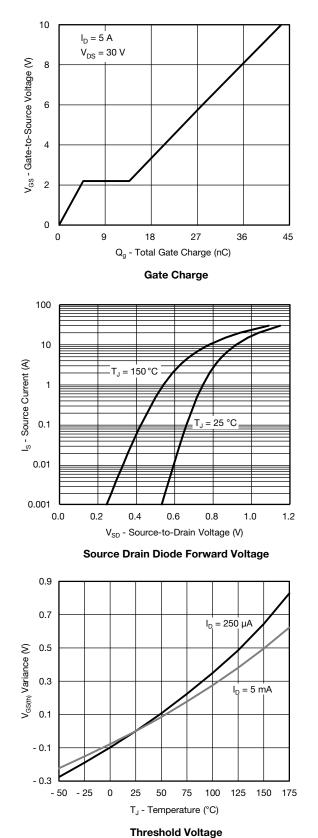
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

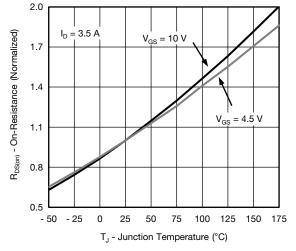




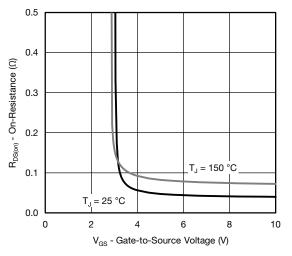


TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

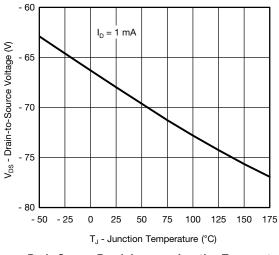




On-Resistance vs. Junction Temperature





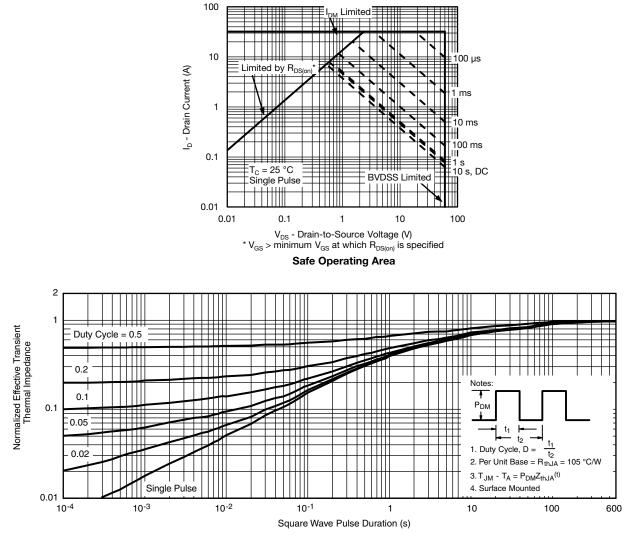


Drain Source Breakdown vs. Junction Temperature

SI9407BDY-T1-GE3-VB



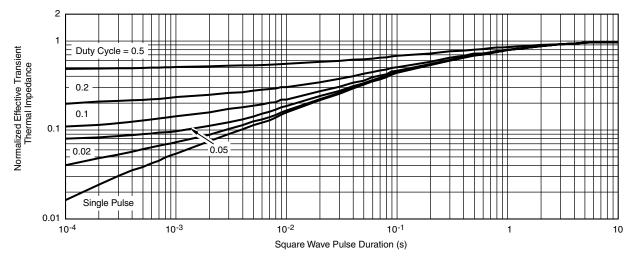
THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

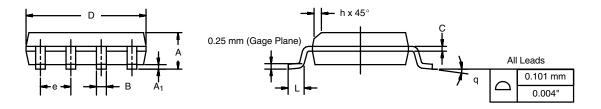
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

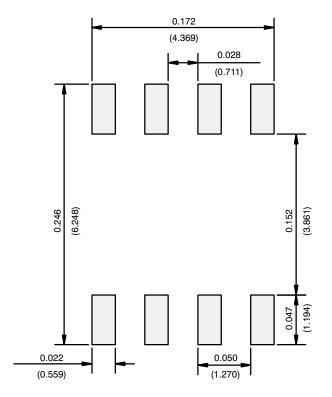




	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
А	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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